

Customer No.: 31561  
Application No.: 10/711,677  
Docket No.: 13130-US-PA

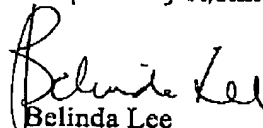
**REMARKS**

In response to the Office Action, mailed on January 20, 2006, a complete listing of all of the claims is presented herewith. Applicants would like to elect Group I, claims 1-14, drawn to thin film transistor array substrate, classified in class 257, subclass 223. Please cancel Group II, claims 15-20, drawn to method of thin film transistor array substrate, classified in class 438, subclass 75, without waiver, prejudice or disclaimer.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date : February 20, 2006

Respectfully submitted,

  
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